

SILICON PLANAR EPITAXIAL TRANSISTORS

N-P-N silicon transistors, in a microminiature plastic package intended for switching and linear applications in thick and thin-film circuits.

QUICK REFERENCE DATA

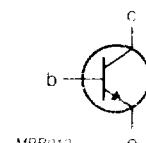
	BSR13	BSR14
Collector-base voltage (open emitter)	V _{CBO}	max. 60 75 V
Collector-emitter voltage (open base)	V _{CEO}	max. 30 40 V
Emitter-base voltage (open collector)	V _{EBO}	max. 5 6 V
Collector current (d.c.)	I _C	max. 800 mA
Total power dissipation up to T _{amb} = 25 °C	P _{tot}	max. 250 mW
Junction temperature	T _j	max. 150 °C
D.C. current gain	h _{FE}	100 to 300
I _C = 150 mA; V _{CE} = 10 V	h _{FE}	> 30 40
I _C = 500 mA; V _{CE} = 10 V		
Transition frequency at f = 100 MHz	f _T	> 250 300 MHz
I _C = 20 mA, V _{CE} = 20 V		

MECHANICAL DATA

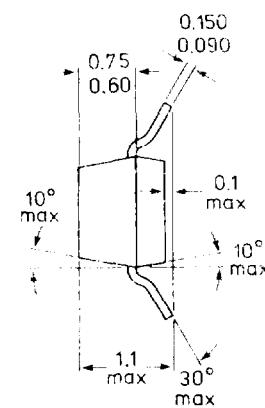
Fig. 1 SOT-23.

Pinning:

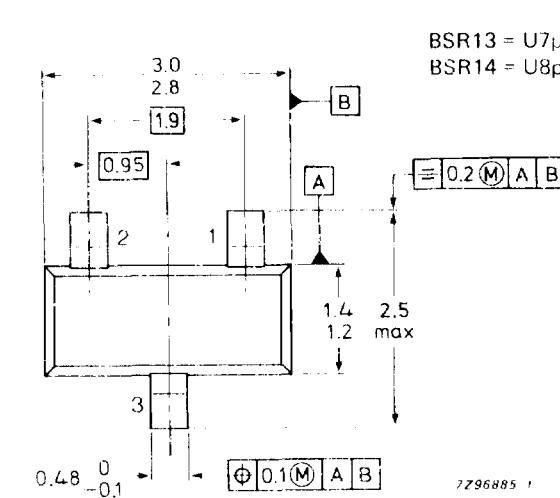
- 1 = base
- 2 = emitter
- 3 = collector



MMBT012



Dimensions in mm



BSR13 = U7µ
BSR14 = U8p

7796885

TOP VIEW

Reverse pinning types are available on request.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

			BSR13	BSR14
Collector-base voltage (open emitter)	V_{CBO}	max.	60	75 V
Collector-emitter voltage (open base)	V_{CEO}	max.	30	40 V
Emitter-base voltage (open collector)	V_{EBO}	max.	5	6 V
Collector current (d.c.)	I_C	max.	800	mA
Total power dissipation up to $T_{amb} = 25^\circ\text{C}$	P_{tot}	max.	250	mW
Storage temperature	T_{stg}		-65 to +150	$^\circ\text{C}$
Junction temperature	T_j	max.	150	$^\circ\text{C}$

THERMAL RESISTANCE

From junction to ambient*	$R_{th j-a}$	=	500	K/W
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CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified

			BSR13	BSR14
Collector cut-off current				
$I_E = 0; V_{CB} = 50 \text{ V}$	I_{CBO}	<	30	— nA
$I_E = 0; V_{CB} = 60 \text{ V}$	I_{CBO}	<	—	10 nA
$I_E = 0; V_{CB} = 50 \text{ V}; T_j = 150^\circ\text{C}$	I_{CBO}	<	10	— μA
$I_E = 0; V_{CB} = 60 \text{ V}; T_j = 150^\circ\text{C}$	I_{CBO}	<	—	10 μA
$V_{EB} = 3 \text{ V}; V_{CE} = 60 \text{ V}$	I_{CEX}	<	—	10 nA
Base current				
with reverse biased emitter junction				
$V_{EB} = 3 \text{ V}; V_{CE} = 60 \text{ V}$	I_{BEX}	<	—	20 nA
Emitter cut-off current				
$I_C = 0; V_{EB} = 3 \text{ V}$	I_{EBO}	<	30	15 nA
Saturation voltages				
$I_C = 150 \text{ mA}; I_B = 15 \text{ mA}$	V_{CEsat}	<	400	300 mV
	V_{BEsat}	<	1300	— mV
	V_{BEsat}	—	0,6 to 1,2	V
$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}$	V_{CEsat}	<	1600	1000 mV
	V_{BEsat}	<	2600	2000 mV

* Mounted on an FR4 printed-circuit board 8 mm x 10 mm x 0.7 mm.

D.C. current gain *

$I_C = 0,1 \text{ mA}; V_{CE} = 10 \text{ V}$	h_{FE}	> 35
$I_C = 1 \text{ mA}; V_{CE} = 10 \text{ V}$	h_{FE}	> 50
$I_C = 10 \text{ mA}; V_{CE} = 10 \text{ V}$	h_{FE}	> 75
$I_C = 150 \text{ mA}; V_{CE} = 10 \text{ V}$	h_{FE}	100 to 300
$I_C = 150 \text{ mA}; V_{CE} = 1 \text{ V}$	h_{FE}	> 50
$I_C = 500 \text{ mA}; V_{CE} = 10 \text{ V}$	h_{FE}	> 30
$I_C = 500 \text{ mA}; V_{CE} = 10 \text{ V}$	h_{FE}	> 40

Transition frequency at $f = 100 \text{ MHz}$

$I_C = 20 \text{ mA}; V_{CE} = 20 \text{ V}$	BSR13; R	f_T	> 250	MHz
$I_C = 20 \text{ mA}; V_{CE} = 20 \text{ V}$	BSR14; R	f_T	> 300	MHz

Collector capacitance at $f = 1 \text{ MHz}$

$I_E = I_e = 0; V_{CB} = 10 \text{ V}$	C_C	< 8	pF
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 h parameters (common emitter) at $f = 1 \text{ kHz}$

$I_C = 1 \text{ mA}; V_{CE} = 10 \text{ V}$	h_{ie}	2 to 8	k Ω
input impedance	h_{re}	< 8.10^{-4}	
reverse voltage transfer ratio	h_{fe}	50 to 300	
small signal current gain	h_{oe}	5 to 35	μs
output admittance			
$I_C = 10 \text{ mA}; V_{CE} = 10 \text{ V}$	h_{ie}	0,25 to 1,25	k Ω
input impedance	h_{re}	< 4.10^{-4}	
reverse voltage transfer ratio	h_{fe}	75 to 375	
small signal current gain	h_{oe}	25 to 200	μs
output admittance			

* Measured under pulsed conditions to avoid excessive dissipation; pulse duration $t_p \leq 300 \mu\text{s}$; duty factor $\delta \leq 0,02$.

Switching times (between 10% and 90% levels)

Turn-on time switched to $I_C = 150 \text{ mA}$ (see Fig. 2)

delay time
rise time

	BSR14	
t_d	<	10 ns
t_r	<	25 ns

Turn-off time switched from $I_C = 150 \text{ mA}$ (see Fig. 3)

storage time
fall time

	BSR14	
t_s	<	225 ns
t_f	<	60 ns

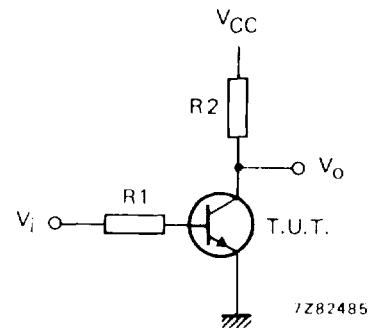
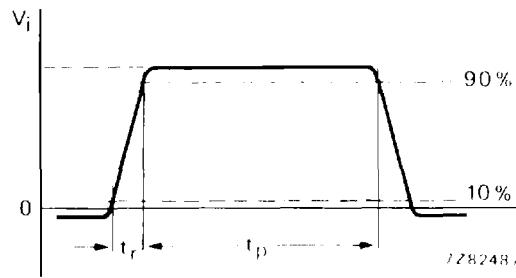


Fig. 2 Waveform and test circuit delay and rise time.

$V_i = -0,5 \text{ to } +9,9 \text{ V}$; $V_{CC} = 30 \text{ V}$; $R1 = 619 \Omega$; $R2 = 200 \Omega$.

Pulse generator:

pulse duration	t_p	\leq	200 ns
rise time	t_r	\leq	2 ns
duty factor	δ	=	2 %

Oscilloscope:

input impedance	Z_i	$>$	100 k Ω
input capacitance	C_i	$<$	12 pF
rise time	t_r	\leq	5 ns

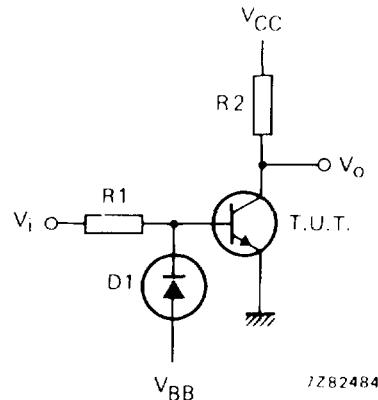
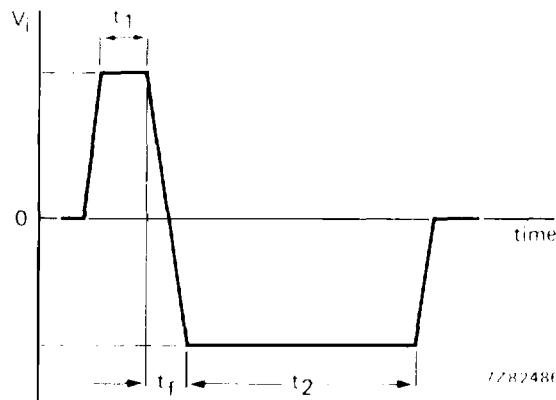


Fig. 3 Waveform and test circuit storage and fall time.

$V_i = -13,8 \text{ to } +16,2 \text{ V}$; $V_{CC} = 30 \text{ V}$; $V_{BB} = 3 \text{ V}$; $R1 = 1 \text{ k}\Omega$; $R2 = 200 \Omega$.

Pulse generator:

fall time	t_f	$<$	5 ns
pulse time	t_1	=	100 μs
	t_2	=	500 μs

Oscilloscope:

input impedance	Z_i	$>$	100 k Ω
input capacitance	C_i	$<$	12 pF
rise time	t_r	\leq	5 ns